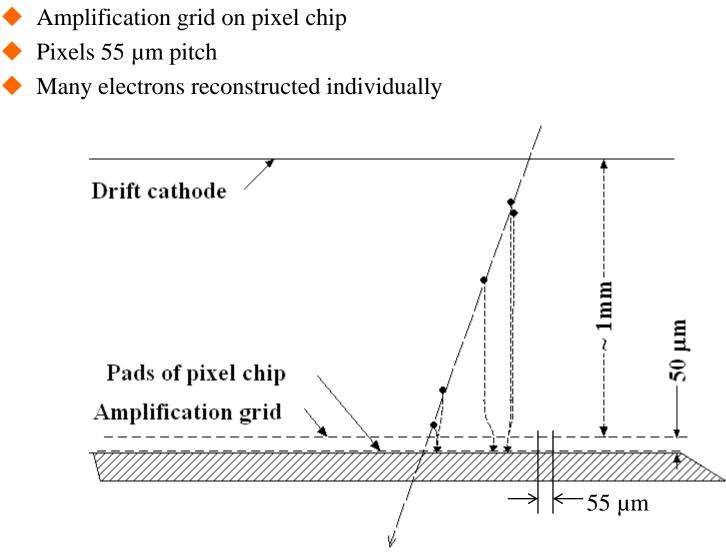


Characterisation of protection layers in pixelised MPGDs

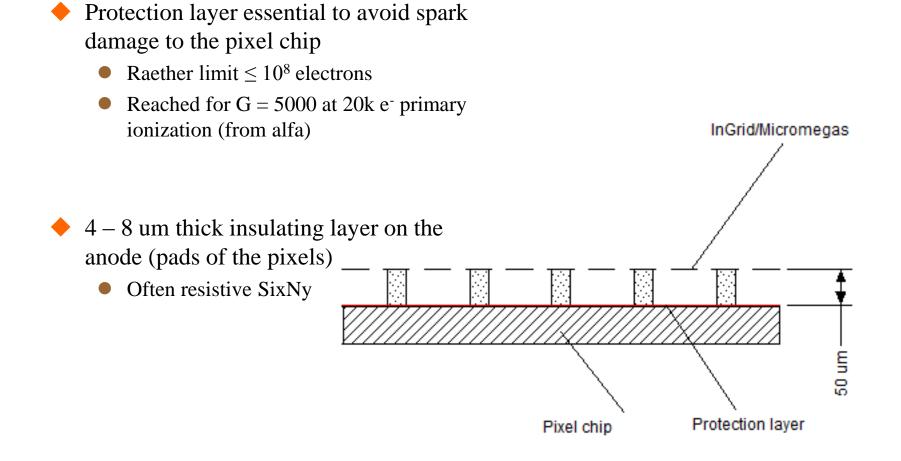
Harry van der Graaf and Fred Hartjes NIKHEF

> RD51 miniweek, CERN Dec 9, 2015

Principle GridPix detector

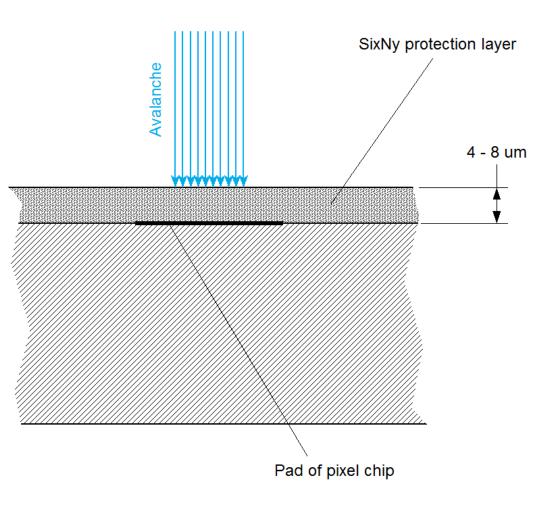


Protection layer in InGrid based pixel detectors



- For normal operation the charge signal (~1 fC) is induced via the layer capacity (6.6 fF) to the pixel
- At a spark discharge (300 600 V) we induce $\leq 2 4 \text{ pC}$ in the pixel input
 - No damage on electronics
 - The charge of the grid may be distributed across a 2 mm wide surface
 - But mostly the discharge is much earlier quenched
- Without protection layer we would inject 10 – 20 nC into a single pixel
 - => fatal damage

Calculations for 4 µm layer thickness

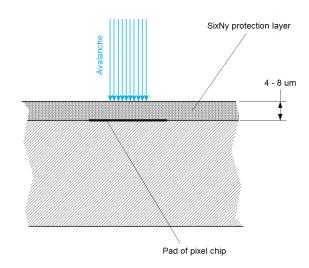


Requirements for the layer resistivity

- The integral of the signal currents creates voltage drop across the layer
 - Reducing the gas gain
- Maximum resistivity dependent on the particle rate and the gas gain

Lower limit on resistivity is given by

- Coupling fast signal to neighbouring pixels
- Affecting the Krummenacher currents

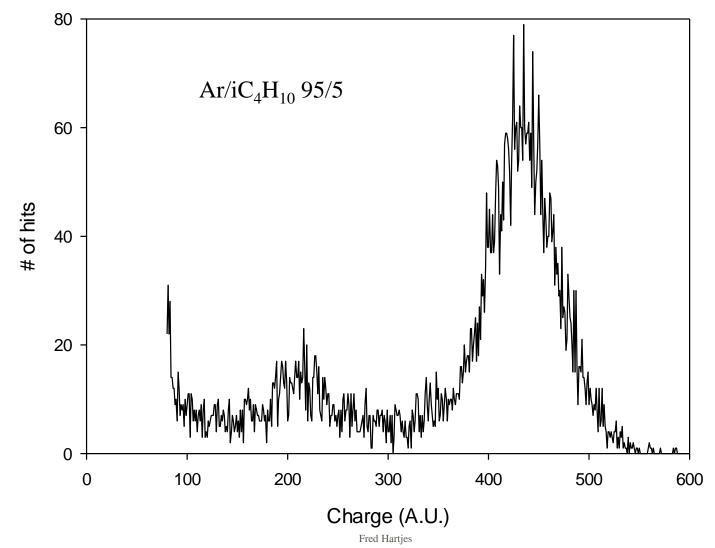


- Example max resistivity
 - Mip rate 0.9 GHz/cm²
 - Gas gain 5000
 - 126 electron/ion pairs per track
 - Maybe minimum value Voltage drop across layer: 10 V (gain reduced by 17% for DME/CO₂ 50/50)
 - => layer resistivity $\leq 1.6 * 10^7 \Omega$.m

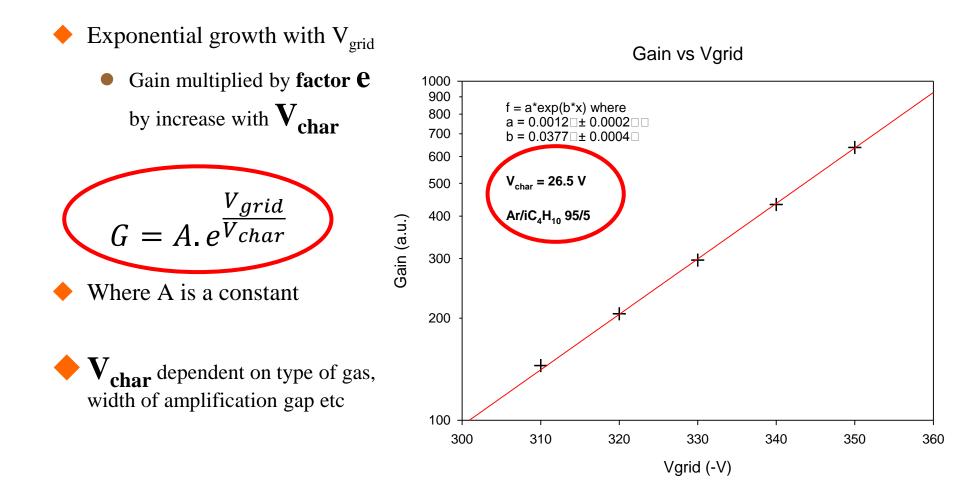
Gain measurements

Measurements of gas gain using ⁵⁵Fe source

⁵⁵Fe measurements



Example of dependence of gas gain on V_{grid}



Measurement of gain reduction by high irradiation rate

7000

- TimePix3 based GridPix detector under irradiation by 5 MBq ⁹⁰Sr on 4 cm distance
 - Gas: DME/CO2 50/50
 - Grid voltage: -610 V
- Gain considerably decreased because of voltage drop across the protection layer
- Plot shows gain recovery after removal source

DME/CO₂ 50/50 6500 $\tau = 1.76 \text{ min}$ 6000 Gas gain 5500 5000 4500 4000 2 12 8 10 14 18 4 6 16 20 0

t (min)

Gas gain recovery after irradiation

⁹⁰Sr source removed

Expressions

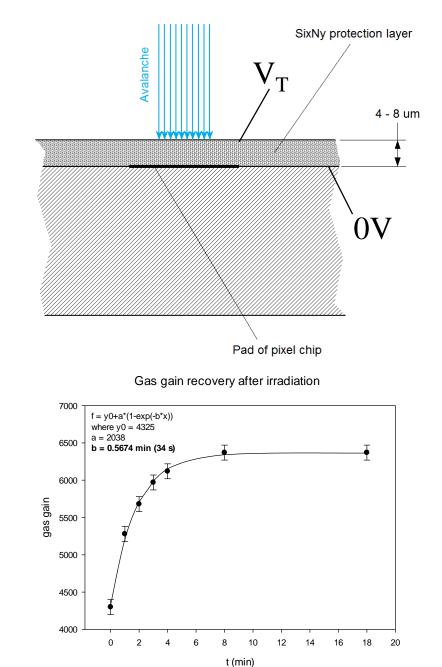
- Potential V_T is formed across the protection layer due to irradiation
- Gain G is reduced according to

$$G = G_u e^{-\frac{V_T}{V_{char}}}$$

 But after removal of the source V_T falls back to zero with time t

$$V_T(t) = V_{T0} e^{-t/_{RC}}$$

 Where V_{T0} is the original potential and RC is the capacity and resistance of the investigated layer surface



The volume resistance of the layer

The RC constant of the layer is independent of the geometry of the investigated layer surface and thickness and can be written as

$$RC = \varepsilon_0. \varepsilon_r. \rho$$

• Where ρ is the **volume resistance** of the layer.

 Consequently we get for the time dependent expression of the gain after removal of the source

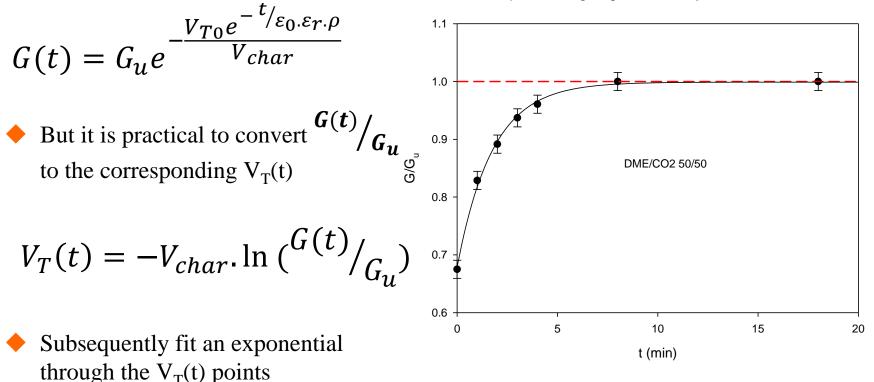
$$G(t) = G_u e^{-\frac{V_{T0}e^{-t}/\varepsilon_0 \cdot \varepsilon_r \cdot \rho}{V_{char}}}$$

• By fitting the double exponential expression to the measured curve, the volume resistance ρ can be determined from the time dependent behaviour

Deducing the value for $\boldsymbol{\rho}$

 One may deduce ρ directly from the curve fit through the measured G(t) values

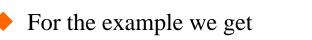
Example of the gas gain recovery after irradiation



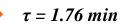
$$V_T(t) = V_{T0} e^{-t/\varepsilon_0 \cdot \varepsilon_r \cdot \rho}$$

Fred Hartjes

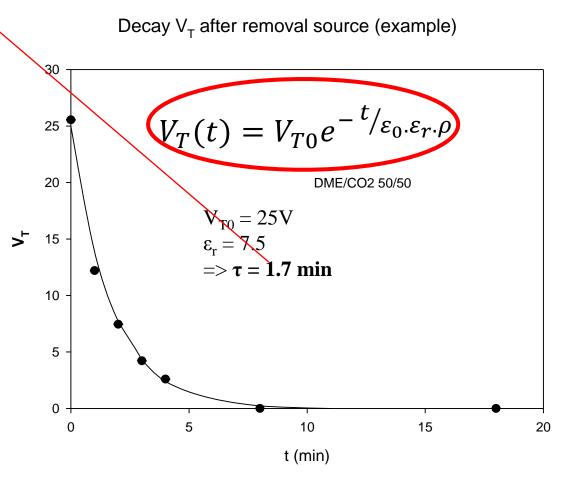
RD51 miniweek CERN, Dec 9, 2015



- $\varepsilon_0^* \varepsilon_r^* \rho = 1.7 \min$
- V_{char} estimated at $\delta 5V$
- For ρ we get accordingly:
- The range in which ρ can be measured extends due to practical constraints from
 - 10¹¹ to 10¹⁷ Ωm
 - $(10^{13} \text{ to } 10^{19} \,\Omega \text{cm})$
 - $(\tau = 10 \text{ s to } 117 \text{ days})$
- Note: a simple exponential fit through the original ${}^{G(t)}/_{G_u}$ curve gives about the same result



Decay of the calculated voltage drop across the protection layer



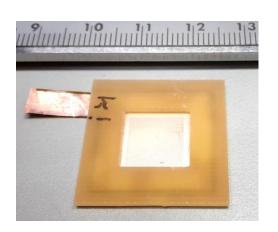
Method to do the ρ measurement of a protection layer?

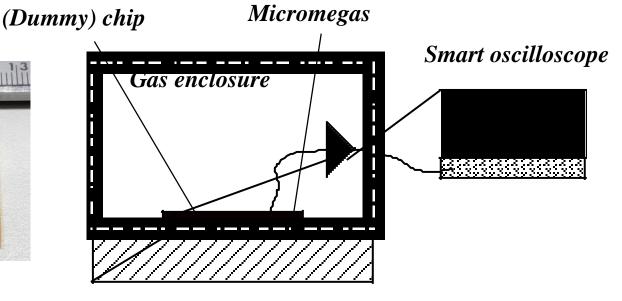
No pixel chip is needed

• can be done well with a dummy piece of silicon

• Just place a dedicated Micromegas on top and put it in gas enclosure

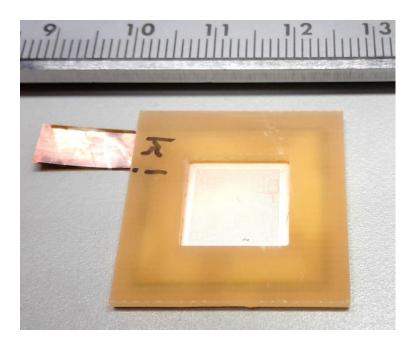
Analyse the induced signals from the Micromegas grid created by the ⁵⁵Fe source



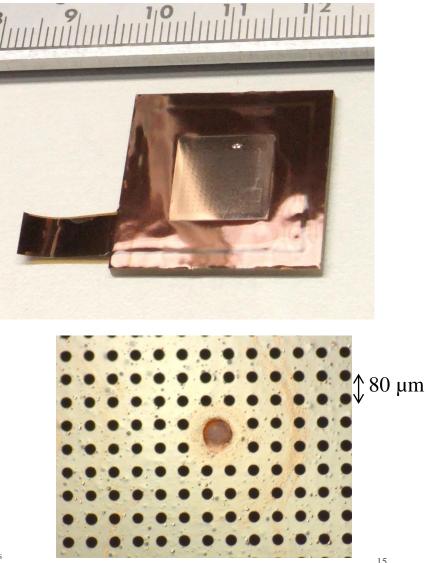


- Designed by Harry van der Graaf
- 5 μm copper on 50 μm Kapton
- 80 µm hole pitch
- Mounted on glass fibre epoxy frame
 - 25 x 25 mm

Fabricated at CERN (Rui De Oliveira)



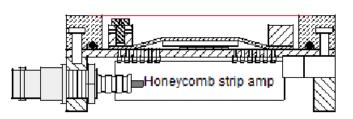
Dedicated Micromegas board

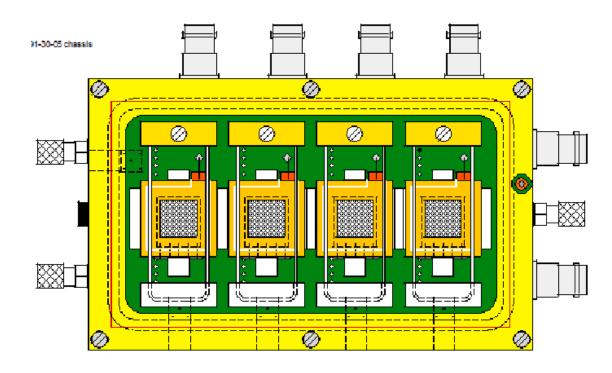


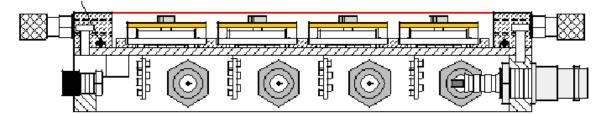
Fred Hartjes

Protection layer test device

- Designed to measure systematically the long term HV tolerance of protection layers
 - Resistivity
 - Breakdown sensitivity under harsh conditions
- 4 channels
 - HV from Nikhef miniHV
 - nA resolution
 - Good detection of sparks

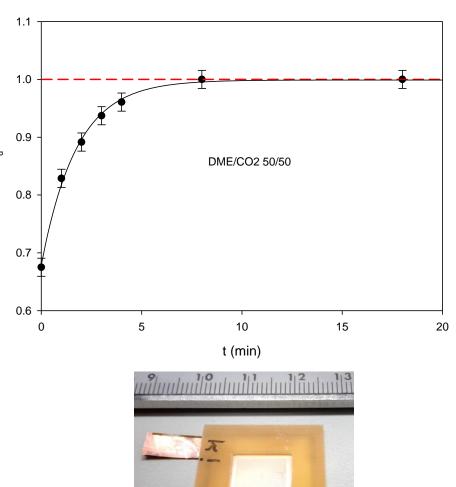






- A pixelized gaseous detector needs a protection layer on the anode to avoid spark damage
- But the detector may experience loss of gain at high counting rates because of voltage drop across the protection layer
- This effect can be reduced by lowering the resistivity of the layer
- We devised a method where from the dynamic response of the gain to external irradiation the volume resistance can be accurately deduced between 10¹¹ and 10¹⁷ Ωm
- Can also be applied for all kinds of layers on a dummy substrate
 - Interesting for MEMS technology

Summary



Example of the gas gain recovery after irradiation